

DATA SHEET

AUTOMOTIVE GRADE HIGH VOLTAGE CHIP RESISTORS

HV series

0.1% FOR 1206, 0.5%, 1%, 5%

Sizes 1206/2010/2512

RoHS compliant



SCOPE

This specification describes HV1206/2010/2512 high voltage chip resistors with lead-free terminations made by thick film process.

APPLICATIONS

- Automotive
- Converter
- Inverter
- Outdoor Equipments
- Photovoltaic industry
- Power supply

FEATURES

- AEC-Q200 Qualified
- RoHS compliant
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Non-forbidden materials used in products/ production
- Halogen Free Epoxy
- Moisture sensitivity level: MSL 1
- GB 4943.1-2022 safety certificate issued by CQC for 2010/2512

* Please refer to CQC certification

ORDERING INFORMATION - GLOBAL PART NUMBER

Both part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

YAGEO BRAND ordering code

GLOBAL PART NUMBER (PREFERRED)

HV XXXX X X X XX XXXX L
(1) (2) (3) (4) (5) (6) (7)

(1) SIZE

1206/2010/2512

(2) TOLERANCE

B = $\pm 0.1\%$

D = $\pm 0.5\%$

F = $\pm 1\%$

J = $\pm 5\%$

(3) PACKAGING TYPE

R = Paper/PE taping reel

K = Embossed taping reel

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

– = Base on spec

E = $\pm 50 \text{ ppm}/^\circ\text{C}$

(5) TAPING REEL

07 = 7 inch dia. Reel

(6) RESISTANCE VALUE

There are 2~4 digits indicated the resistor value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g. 1K2, not 1K20.

Detailed resistance rules show in table of "Resistance rule of global part number".

(7) DEFAULT CODE

Letter L is system default code for ordering only (Note)

Resistance rule of global part number	
Resistance code rule	Example
XXKX (10 to 97.6 K Ω)	10K = 10,000 Ω 97K6 = 97,600 Ω
XXXX (100 to 976 K Ω)	100K = 10,000 Ω 976K = 976,000 Ω
XMXX (1 to 9.76 M Ω)	1M = 1,000,000 Ω 9M76 = 9,760,000 Ω
XXMX (10 to 16 M Ω)	10M = 10,000,000 Ω 27M = 27,000,000 Ω

ORDERING EXAMPLE

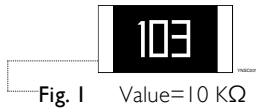
The ordering code of a HV2512 chip resistor, value 1 M Ω with $\pm 5\%$ tolerance, supplied in 7-inch tape reel is: HV2512JK-071ML.

NOTE

1. All our R-Chip products meet RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead Free Process"
2. On customized label, "LFP" or specific symbol printed and the optional "L" at the end of GLOBAL PART NUMBER

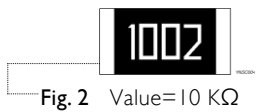
MARKING

HV 1206/2010/2512

E-24 series: 3 digits, $\pm 5\%$

First two digits for significant figure and 3rd digit for number of zeros

HV 1206/2010/2512

Both E-24 and E-96 series: 4 digits, $\pm 0.5\%$ & $\pm 1\%$

First three digits for significant figure and 4th digit for number of zeros

For further marking information, please refer to data sheet "Chip resistors marking".

CONSTRUCTION

The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added on each end to make the contacts to the thick film resistive element. The composition of the resistive element is a noble metal imbedded into a glass and covered by a second glass to prevent environment influences. The resistor is laser trimmed to the rated resistance value. The resistor is covered with a protective epoxy coat, finally the two external terminations (matte tin on Ni-barrier) are added. See fig.3

DIMENSIONS

Table I For outlines see fig. 3

TYPE	L (mm)	W (mm)	H (mm)	I_1 (mm)	I_2 (mm)
HV1206	3.10 ± 0.10	1.60 ± 0.15	0.55 ± 0.10	0.40 ± 0.20	0.45 ± 0.20
HV2010	5.00 ± 0.10	2.50 ± 0.15	0.55 ± 0.10	0.55 ± 0.15	0.55 ± 0.20
HV2512	6.35 ± 0.10	3.10 ± 0.15	0.55 ± 0.10	0.60 ± 0.20	0.60 ± 0.20

OUTLINES

For dimension see Table I

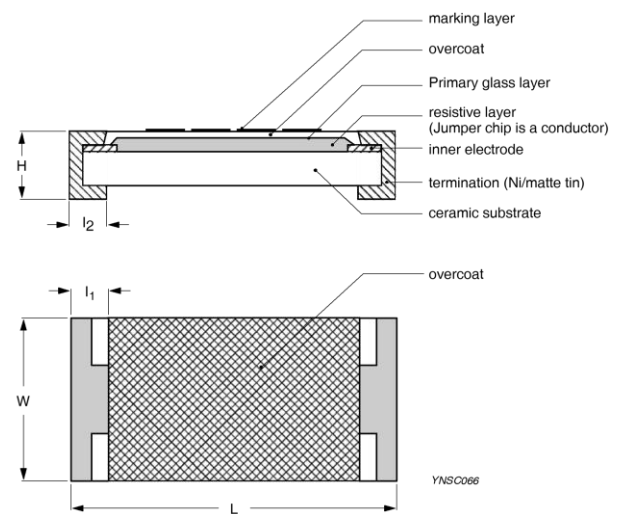


Fig. 3 Chip resistor outlines

ELECTRICAL CHARACTERISTICS

Table 2

TYPE	RESISTANCE RANGE	CHARACTERISTICS					
		Rated Power	Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	Temperature Coefficient of Resistance
HV1206	5% (E-24) 47Ω to 27MΩ	1/3W	-55 °C to +155 °C	1,000V	1,500V	1,500V	47Ω≤R≤10MΩ ±100ppm°C ± 50ppm°C for HV1206 0.1% 10MΩ<R≤51MΩ ±200ppm°C
	1% (E-24/E-96) 47Ω to 27MΩ						
	0.5% (E-24/E-96) 47Ω to 10MΩ						
	0.1% (E-24/E-96) 47Ω to 10MΩ						
HV2010	5% (E-24) 47Ω to 22MΩ	3/4W	-55 °C to +155 °C	2,000 V	3,000 V	3,000 V	47Ω≤R≤10MΩ ±100ppm°C ± 50ppm°C for HV1206 0.1% 10MΩ<R≤51MΩ ±200ppm°C
	1% (E-24/E-96) 47Ω to 22MΩ						
	0.5% (E-24/E-96) 47Ω to 10MΩ						
HV2512	5% (E-24) 47Ω to 51MΩ	1 W	-55 °C to +155 °C	3,000 V	4,000 V	4,000 V	47Ω≤R≤10MΩ ±100ppm°C ± 50ppm°C for HV1206 0.1% 10MΩ<R≤51MΩ ±200ppm°C
	1% (E-24/E-96) 47Ω to 51MΩ						
	0.5% (E-24/E-96) 47Ω to 51MΩ						

FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please refer to data sheet “Chip resistors mounting”.

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	HV1206	HV2010	HV2512
Paper/PE taping reel (R)	7" (178 mm)	5,000	---	---
Embossed taping reel (K)	7" (178 mm)	---	4,000	4,000

NOTE

1. For Paper/PE/Embossed tape and reel specification/dimensions, please refer to data sheet “Chip resistors packing”.

FUNCTIONAL DESCRIPTION**OPERATING TEMPERATURE RANGE**

Range: -55 °C to +155 °C

POWER RATING

Each type rated power at 70 °C:

HV1206=1/3W; HV2010=3/4W; HV2512=1W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$V = \sqrt{(P \times R)}$$

or max. working voltage whichever is less

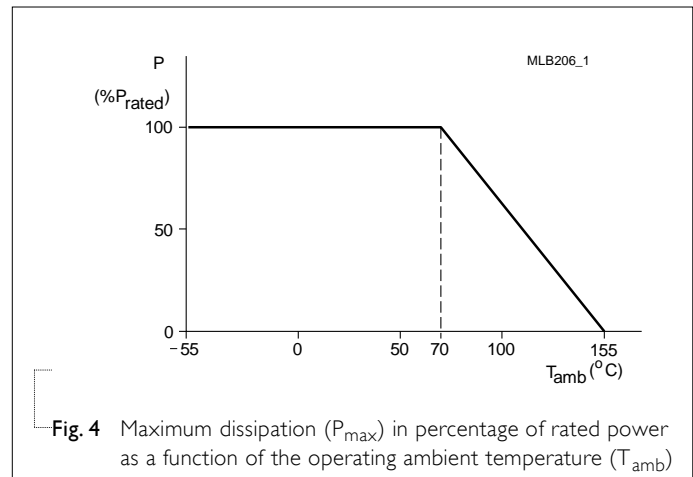
Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

R = Resistance value (Ω)

Maximum working voltage can be applicable to resistors only if the resistance value is equal to or higher than the critical resistance value.



TESTS AND REQUIREMENTS**Table 4** Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
High Temperature Exposure	AEC-Q200 Test 3 MIL-STD-202 Method 108	1,000 hours at $T_A = 155\text{ }^{\circ}\text{C}$, unpowered	$\pm(1.0\%+0.05\Omega)$ for B/D/F tol $\pm(2.0\%+0.05\Omega)$ for J tol <50 m Ω for Jumper
Moisture Resistance	MIL-STD-202 Method 106	Each temperature / humidity cycle is defined at 8 hours, 3 cycles / 24 hours for 10d. with $25\text{ }^{\circ}\text{C}$ / $65\text{ }^{\circ}\text{C}$ 95% R.H, without steps 7a & 7b, unpowered	$\pm(0.5\%+0.05\Omega)$ for B/D/F tol $\pm(2.0\%+0.05\Omega)$ for J tol <100 m Ω for Jumper
Biased Humidity	AEC-Q200 Test 7 MIL-STD-202 Method 103	1,000 hours; $85\text{ }^{\circ}\text{C}$ / 85% RH 10% of operating power Measurement at 24 ± 4 hours after test conclusion.	$\pm(3.0\%+0.05\Omega)$ <100 m Ω for Jumper
Operational Life	AEC-Q200 Test 8 MIL-STD-202 Method 108	1,000 hours at $125\text{ }^{\circ}\text{C}$, derated voltage applied for 1.5 hours on, 0.5 hour off, still-air required	$\pm(1.0\%+0.05\Omega)$ for B/D/F tol $\pm(3.0\%+0.05\Omega)$ for J tol <100 m Ω for Jumper
Resistance to Soldering Heat	AEC-Q200 Test 15 MIL-STD-202 Method 210	Condition B, no pre-heat of samples Lead-free solder, $260\pm 5\text{ }^{\circ}\text{C}$, 10 ± 1 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	$\pm(0.5\%+0.05\Omega)$ for B/D/F tol $\pm(1.0\%+0.05\Omega)$ for J tol <50 m Ω for Jumper No visible damage
Thermal Shock	MIL-STD-202 Method 107	$-55/+125\text{ }^{\circ}\text{C}$ Number of cycles is 300. Devices mounted Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air	$\pm(0.5\%+0.05\Omega)$ for B/D/F tol $\pm(1.0\%+0.05\Omega)$ for J tol <50 m Ω for Jumper
ESD	AEC-Q200 Test 17 AEC-Q200-002	Human Body Model, $I_{\text{pos.}} + I_{\text{neg.}}$ discharges 0201: 500V 0402/0603: 1KV 0805 and above: 2KV	$\pm(3.0\%+0.05\Omega)$ <50 m Ω for Jumper

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Solderability - Wetting	AEC-Q200 Test I8 J-STD-002	Electrical Test not required Magnification 50X SMD conditions: (a) Method B, aging 4 hours at 155 °C dry heat, dipping at 235±3 °C for 5±0.5 seconds. (b) Method B, steam aging 8 hours, dipping at 215±3 °C for 5±0.5 seconds. (c) Method D, steam aging 8 hours, dipping at 260±3 °C for 30±0.5 seconds.	Well tinned (≥95% covered) No visible damage
Board Flex	AEC-Q200 Test 21 AEC-Q200-005	Chips mounted on a 100mm × 40mm glass epoxy resin PCB (FR4) Bending for 0201/0402: 5 mm 0603/0805: 3 mm 1206 and above: 2 mm Holding time: minimum 60 seconds	±(1.0%+0.05Ω) <50 mΩ for Jumper
Temperature Coefficient of Resistance (T.C.R.)	MIL-STD-202 Method 304	At +25/-55 °C and +25/+125 °C Formula: $T.C.R. = \frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)}$ Where t ₁ =+25 °C or specified room temperature t ₂ =-55 °C or +125 °C test temperature R ₁ =resistance at reference temperature in ohms R ₂ =resistance at test temperature in ohms	Refer to table 2
Short Time Overload	IEC60115-1 8.1	2.5 times of rated voltage or maximum overload voltage whichever is less for 5 sec at room temperature	±(1.0%+0.05Ω) for B/D/F tol ±(2.0%+0.05Ω) for J tol <50 mΩ for Jumper

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 3	Oct. 30, 2024	-	- Extend range of HV2512 to 51Mohm
Version 2	Jan. 10, 2024	-	- Add HV1206
Version 1	Sep. 5, 2023	-	- Add GB 4943.1-2022 safety certificate declaration
Version 0	Aug. 19, 2021	-	- First issue

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